

2SK3370

Silicon N Channel MOS FET
High Speed Power Switching

HITACHI

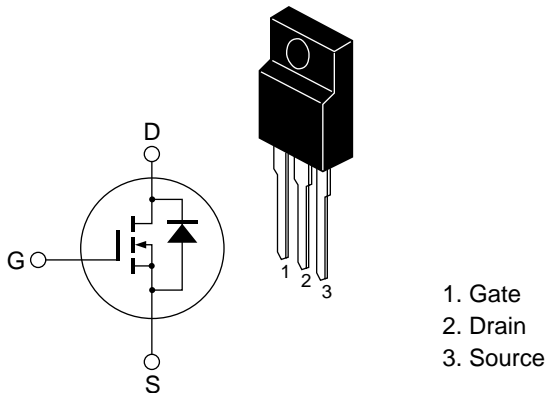
ADE-208-938 (Z)
1st. Edition
Mar. 2001

Features

- Low on-resistance
 $R_{DS(on)} = 6.0 \text{ m } \Omega$ typ.
- 4 V gate drive device
- High speed switching

Outline

TO-220CFM



Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Value	Unit
Drain to source voltage	V_{DSS}	60	V
Gate to source voltage	V_{GSS}	±20	V
Drain current	I_D	60	A
Drain peak current	I_D (pulse) ^{Note1}	240	A
Body-drain diode reverse drain current	I_{DR}	60	A
Avalanche current	I_{AP} ^{Note3}	50	A
Avalanche energy	E_{AR} ^{Note3}	214	mJ
Channel dissipation	P_{ch} ^{Note2}	35	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

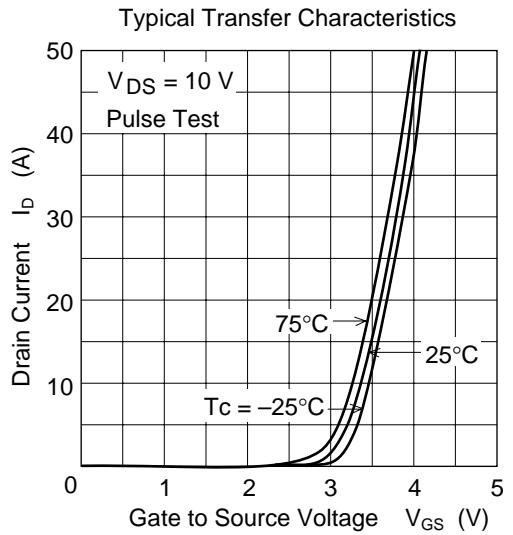
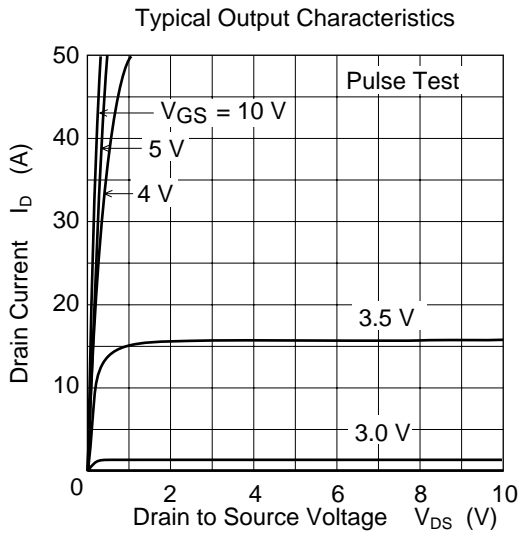
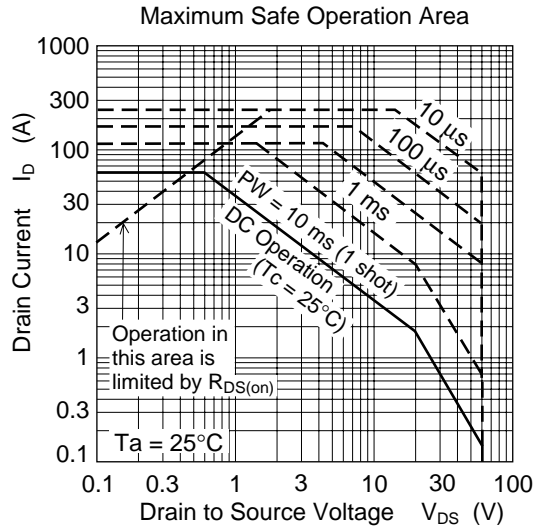
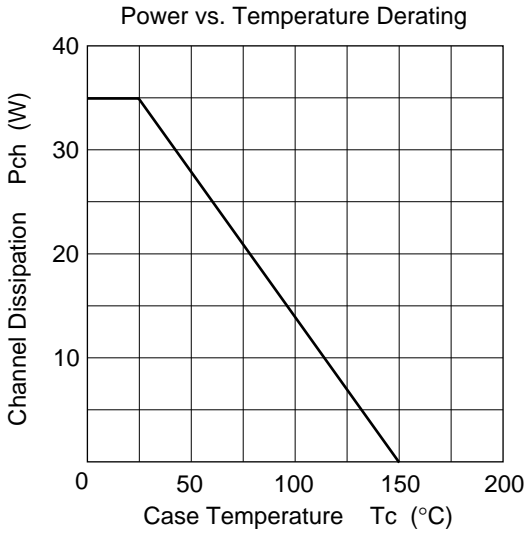
- Notes: 1. $PW \leq 10 \mu s$, duty cycle $\leq 1\%$
2. Value at $T_c = 25^\circ C$
3. Value at $T_{ch} = 25^\circ C$: $R_g \geq 50 \Omega$

Electrical Characteristics (Ta = 25°C)

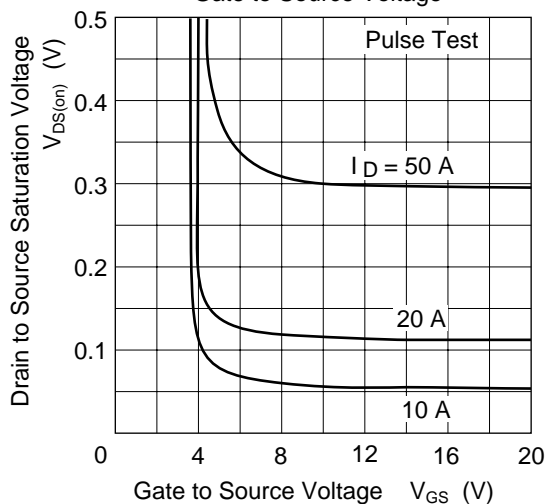
Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	60	—	—	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source leak current	I_{GSS}	—	—	± 0.1	μA	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	10	μA	$V_{DS} = 60 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.5	—	3.0	V	$V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}^{*1}$
Forward transfer admittance	$ y_{fs} $	40	65	—	S	$I_D = 30 \text{ A}, V_{DS} = 10 \text{ V}^{*1}$
Static drain to source on state resistance	$R_{DS(on)}$	—	6.0	8.0	$\text{m}\Omega$	$I_D = 30 \text{ A}, V_{GS} = 10 \text{ V}^{*1}$
	$R_{DS(on)}$	—	9.0	15	$\text{m}\Omega$	$I_D = 30 \text{ A}, V_{GS} = 4.5 \text{ V}^{*1}$
Input capacitance	C_{iss}	—	4700	—	pF	$V_{DS} = 10 \text{ V}$
Output capacitance	C_{oss}	—	950	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	C_{rss}	—	350	—	pF	$f = 1 \text{ MHz}$
Total gate charge	Q_g	—	90	—	nc	$V_{DD} = 50 \text{ V}$
Gate to source charge	Q_{gs}	—	20	—	nc	$V_{GS} = 10 \text{ V}$
Gate to drain charge	Q_{gd}	—	24	—	nc	$I_D = 60 \text{ A}$
Turn-on delay time	$t_{d(on)}$	—	50	—	ns	$V_{GS} = 10 \text{ V}$
Rise time	t_r	—	250	—	ns	$I_D = 30 \text{ A}$
Turn-off delay time	$t_{d(off)}$	—	300	—	ns	$R_L = 1.0 \Omega$
Fall time	t_f	—	220	—	ns	
Body-drain diode forward voltage	V_{DF}	—	1.0	—	V	$I_F = 60 \text{ A}, V_{GS} = 0$
Body-drain diode reverse recovery time	t_{rr}	—	90	—	ns	$I_F = 60 \text{ A}, V_{GS} = 0$ $di_F/dt = 50 \text{ A}/\mu\text{s}$

Note: 1. Pulse test

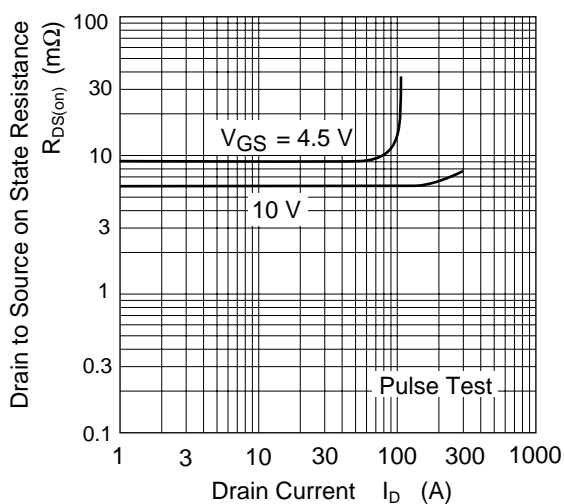
Main Characteristics



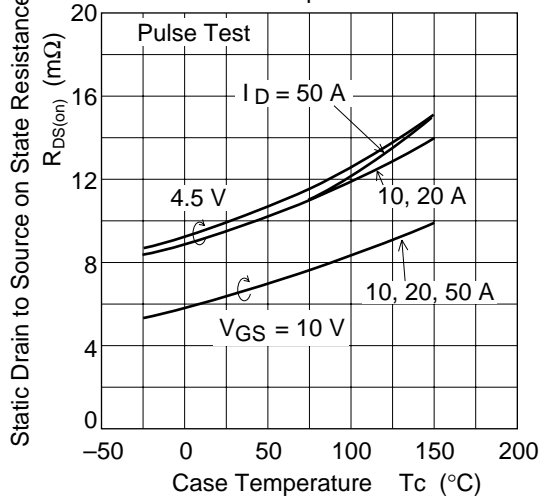
Drain to Source Saturation Voltage vs. Gate to Source Voltage



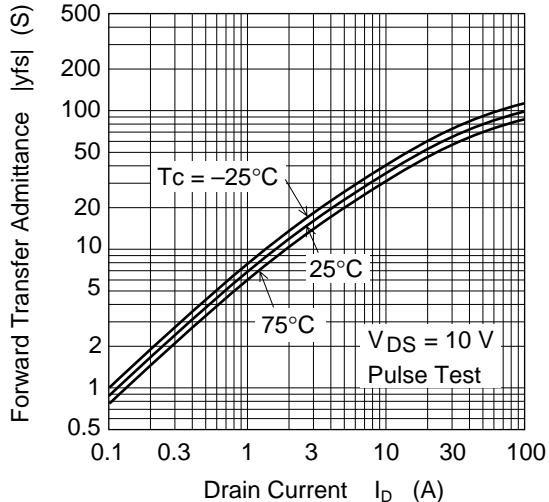
Static Drain to Source on State Resistance vs. Drain Current

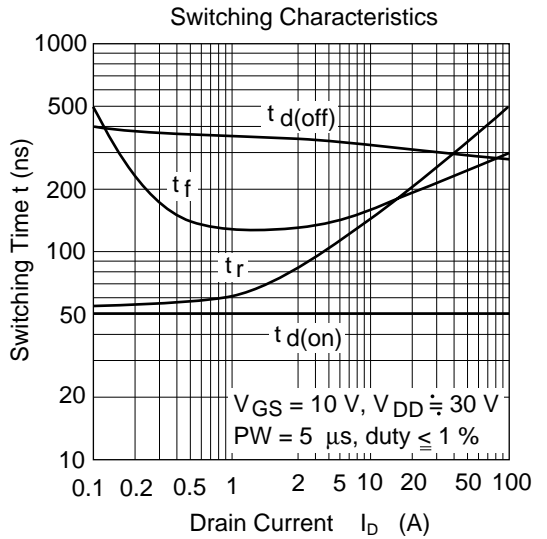
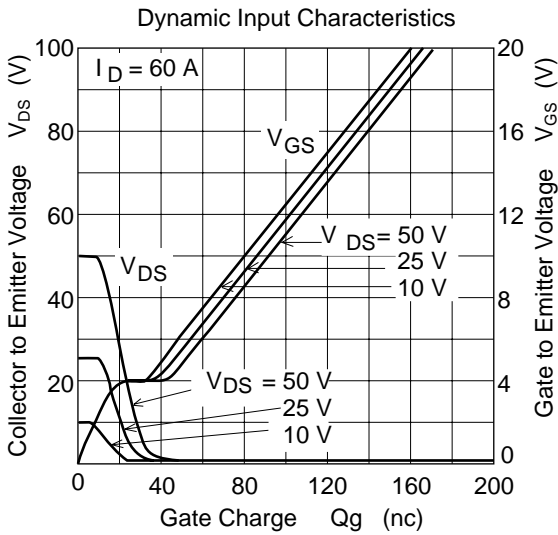
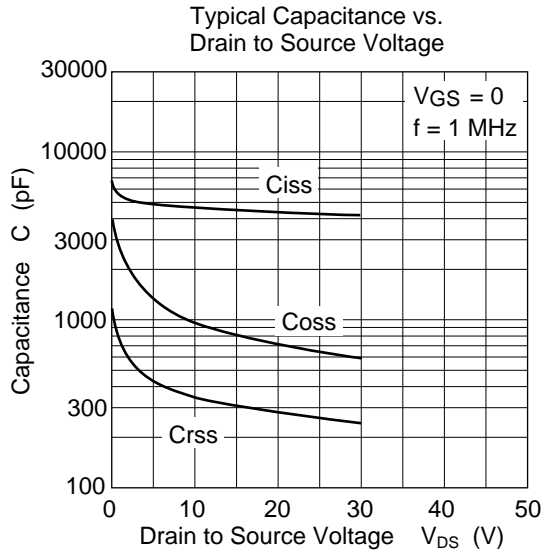
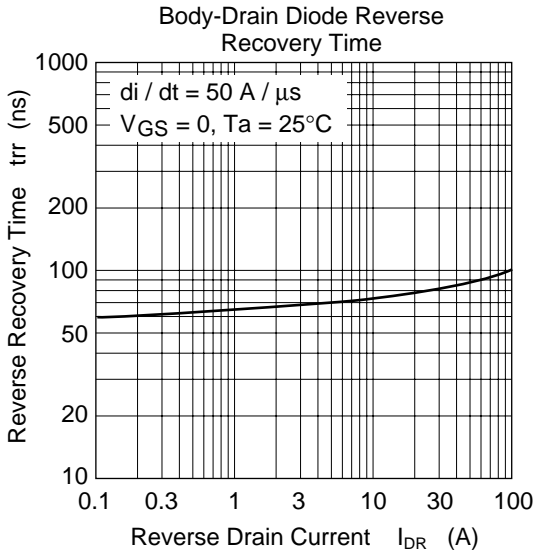


Drain to Source on State Resistance vs. Temperature

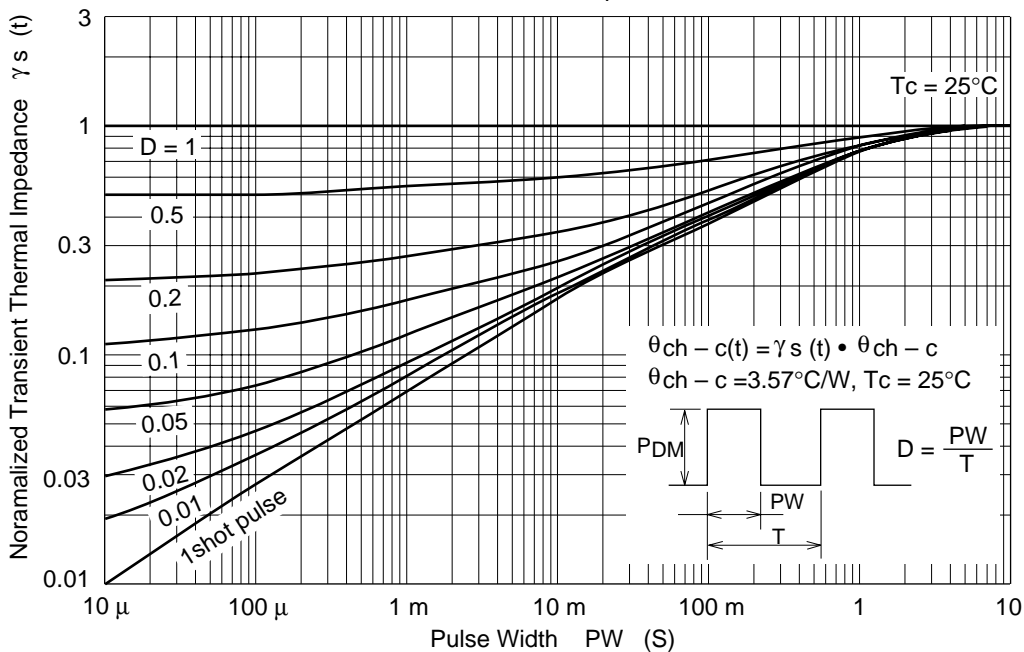


Forward Transfer Admittance vs. Drain Current

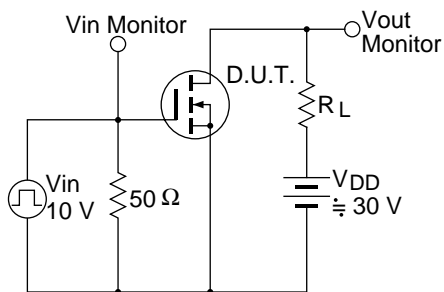




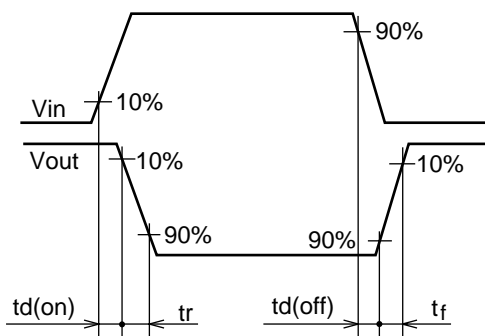
Normalized Transient Thermal Impedance vs. Pulse Width

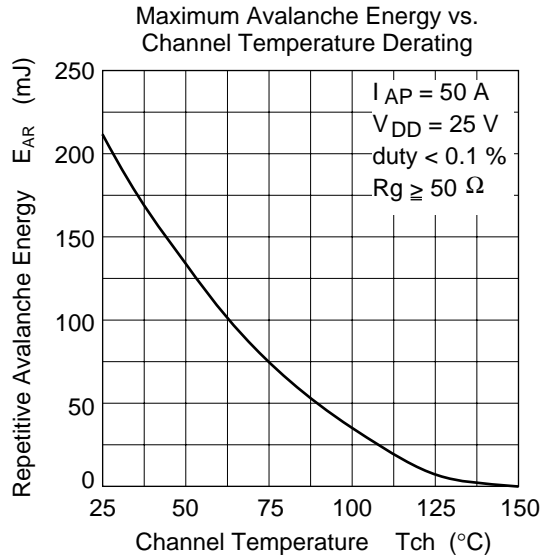
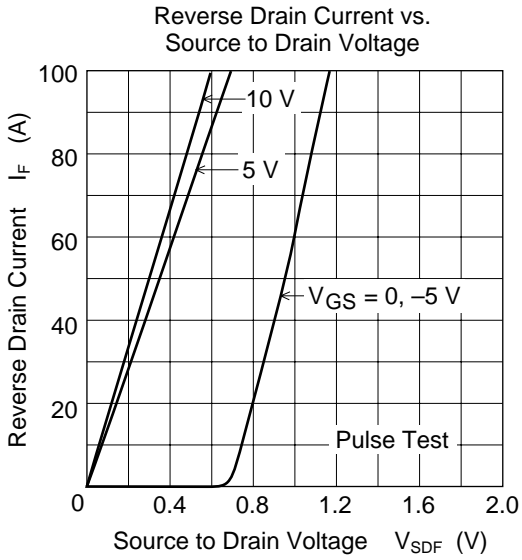


Switching Time Test Circuit

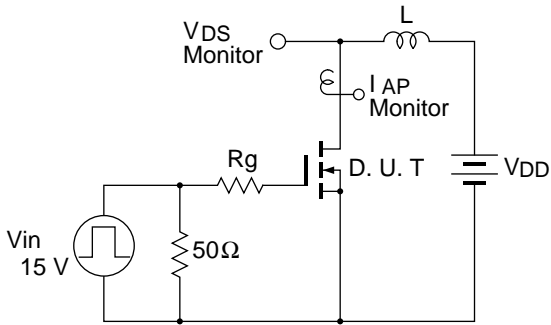


Waveform



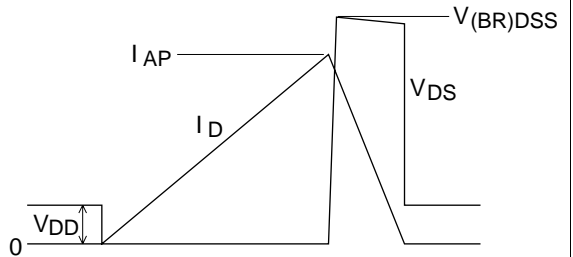


Avalanche Test Circuit



Avalanche Waveform

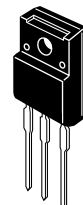
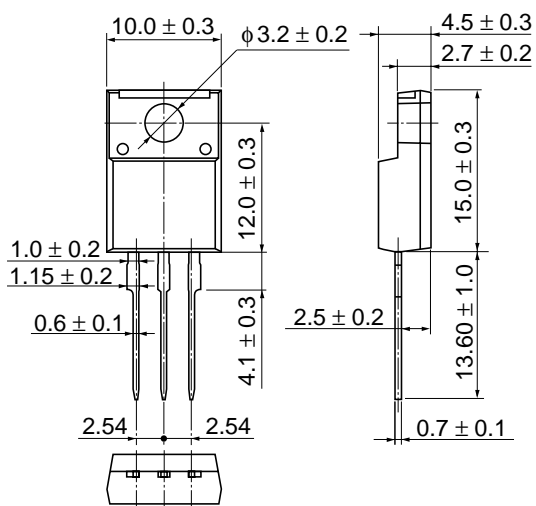
$$E_{AR} = \frac{1}{2} \cdot L \cdot I_{AP}^2 \cdot \frac{V_{DSS}}{V_{DSS} - V_{DD}}$$



Package Dimensions

As of January, 2001

Unit: mm



Hitachi Code	TO-220CFM
JEDEC	—
EIAJ	—
Mass (reference value)	1.9 g

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